Innovating Energy Technology

FMP07N60S1

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FUJI POWER MOSFET

Super J MOS® S1 series

N-Channel enhancement mode power MOSFET

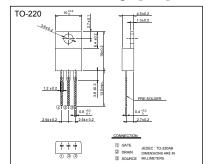
Features

Pb-free lead terminal RoHS compliant

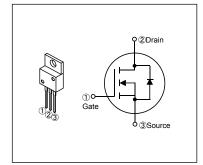
Applications

For switching

Outline Drawings [mm]



Equivalent circuit schematic



■ Absolute Maximum Ratings at T_c=25°C (unless otherwise specified)

Description	Symbol	Characteristics	Unit	Remarks
Drain Source Voltage	V _{DS}	600	V	
Drain-Source Voltage	V _{DSX}	600	V	V _{GS} =-30V
Continuous Brain Current	lo RR	DD #6.5	Α	Tc=25°C Note*1
Continuous Drain Current		1 RX 24 (1 1 1 1 1	А	Tc=100°C Note*1
Pulsed Drain Current	lop/	±19.5	A	
Gate-Source Voltage	V _{G9}	5\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	V	
Repetitive and Non-Repetitive Maximum Avalanche Current	TAR	alriet	А	Note *2
Non-Repetitive Maximum Avalanche Energy	THICE PI	203.4	す。 mJ	Note *3
Maximum Drain-Source dV/dt	dVos/dt _= t	顔し、50	kV/μs	V _{DS} ≤ 600V
Peak Diode Recovery dV/dt	dV/dt/s/	ianin915	kV/µs	Note *4
Peak Diode Recovery -di/dt	-di/dt new des	100	A/µs	Note *5
Maximum Power Dissipation (注:新規設計 Use the Operating and Storage Temperature range)	Po	2.02	W	T _a =25°C
		60	VV	Tc=25°C
Operating and Storage TemporatuNote: Du	Tch	150	°C	
Operating and Storage Temperature range	T _{stg}	-55 to +150	°C	

Note *1 : Limited by maximum channel temperature.

Note *2 : T_{ch}≤150°C, See Fig.1 and Fig.2

Note *3 : Starting T_{ch}=25°C, I_{AS}=1.4A, L=190mH, V_{DD}=60V, R_G=50Ω, See Fig.1 and Fig.2

Eas limited by maximum channel temperature and avalanche current. Note *4 : Ir≤-Ip, -di/dt=100A/µs, Vpp≤400V, Vpeak≤BVpss, Tch≤150°C.

Note *5 : IF \leq -ID, dV/dt=15kV/ μ s, VDD \leq 400V, Vpeak \leq BVDSS, Tch \leq 150°C.

■ Electrical Characteristics at T_c=25°C (unless otherwise specified) Static Ratings

Description	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =250μA V _{GS} =0V		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	I _D =250µA V _{DS} =V _{GS}		2.5	3.0	3.5	V
Zero Gate Voltage Drain Current	Inss	V _{DS} =600V V _{GS} =0V	T _{ch} =25°C	-	-	25	μΑ
		V _{DS} =480V V _{GS} =0V	T _{ch} =125°C	-	-	250	
Gate-Source Leakage Current	I _{GSS}	V _{GS} = ± 30V V _{DS} =0V		-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	I _D =3.25A V _{GS} =10V		-	0.49	0.58	Ω
Gate resistance	R _G	f=1MHz, open drain		-	3.4	-	Ω

• Dynamic Ratings

Description	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	g fs	I _D =3.25A V _{DS} =25V	3	6	-	S
Input Capacitance	Ciss	V _{DS} =10V	-	510	-	
Output Capacitance	Coss	V _{GS} =0V	-	1130	-	
Reverse Transfer Capacitance	Crss	f=1MHz	-	100	-	
Effective output capacitance, energy related (Note *6)	C _{o(er)}	V _{GS} =0V V _{DS} =0480V	-	43	-	pF
Effective output capacitance, time related (Note *7)	C _{o(tr)}	V _{cs} =0V V _{Ds} =0480V ID=constant	-	120	-	
Turn-On Time	t _{d(on)}	V _{DD} =400V, V _{GS} =10V/0V I _D =3.25A, R _G =36Ω See Fig.3 and Fig.4	-	9.5	-	
Turn-On Time	t r		-	28	-	ns
	t _{d(off)}		-	73	-	
	tf		-	17.5	-	
Total Gate Charge	Q _G	V _{DD} =480V, I _D =6.5A V _{GS} =10V See Fig.5	-	21	-	
Gate-Source Charge	Q _{GS}		-	7	-	
Gate-Drain Charge	Q _{GD}		-	4.5	-	nC
Drain-Source crossover Charge	Qsw		-	4.5	-	

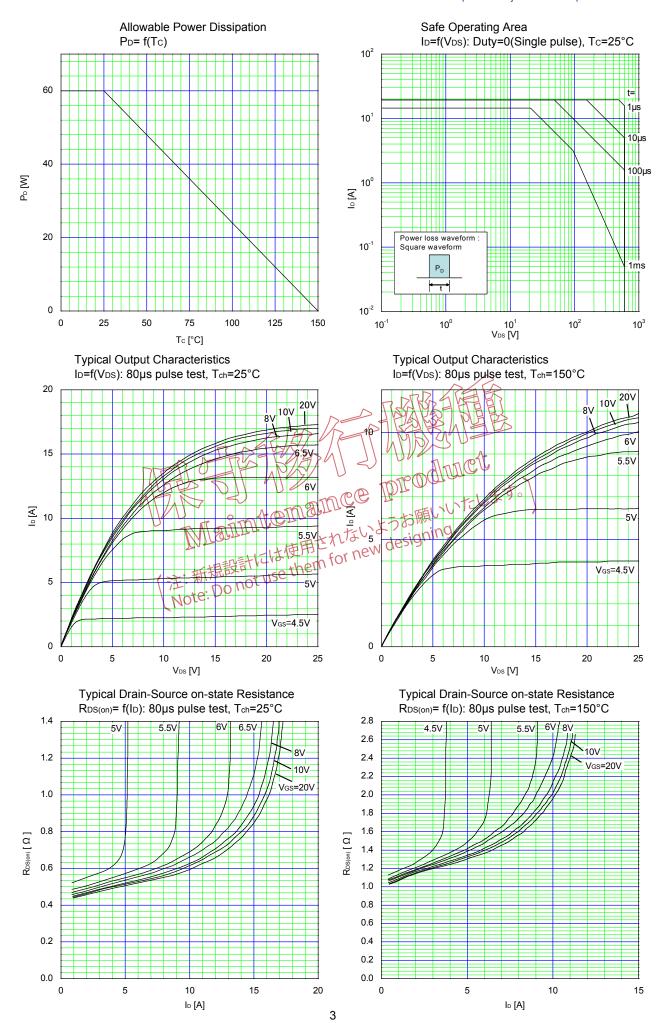
Note *6 : $C_{0(er)}$ is a fixed capacitance that gives the same stored energy as C_{058} while V_{DS} is rising from 0 to 80% BVoss. Note *7 : $C_{0(tr)}$ is a fixed capacitance that gives the same charging times as C_{058} while V_{DS} is rising from 0 to 80% BVoss.

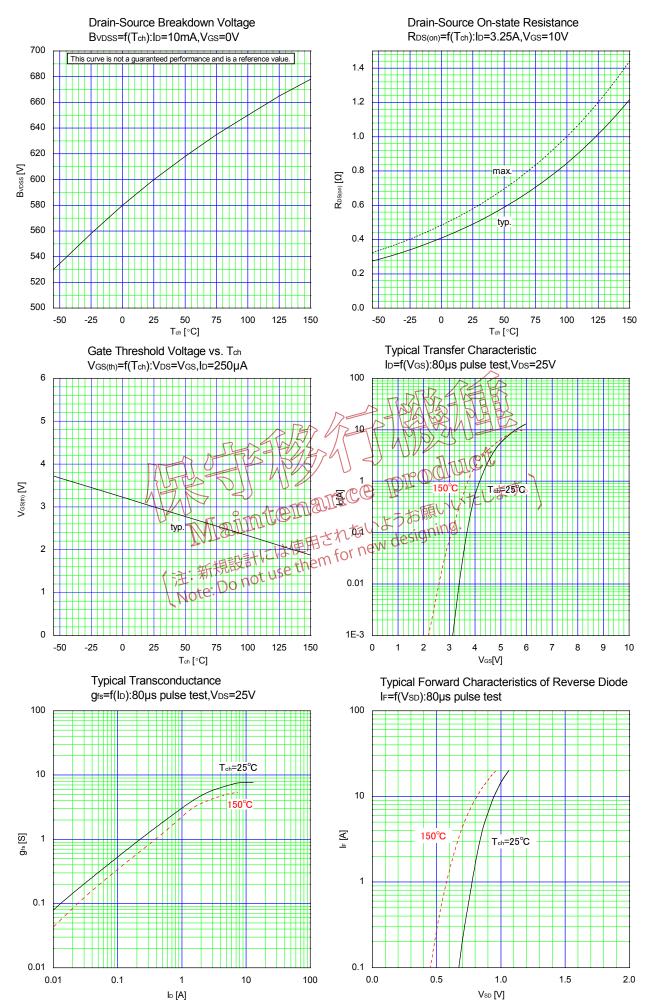
• Reverse Diode

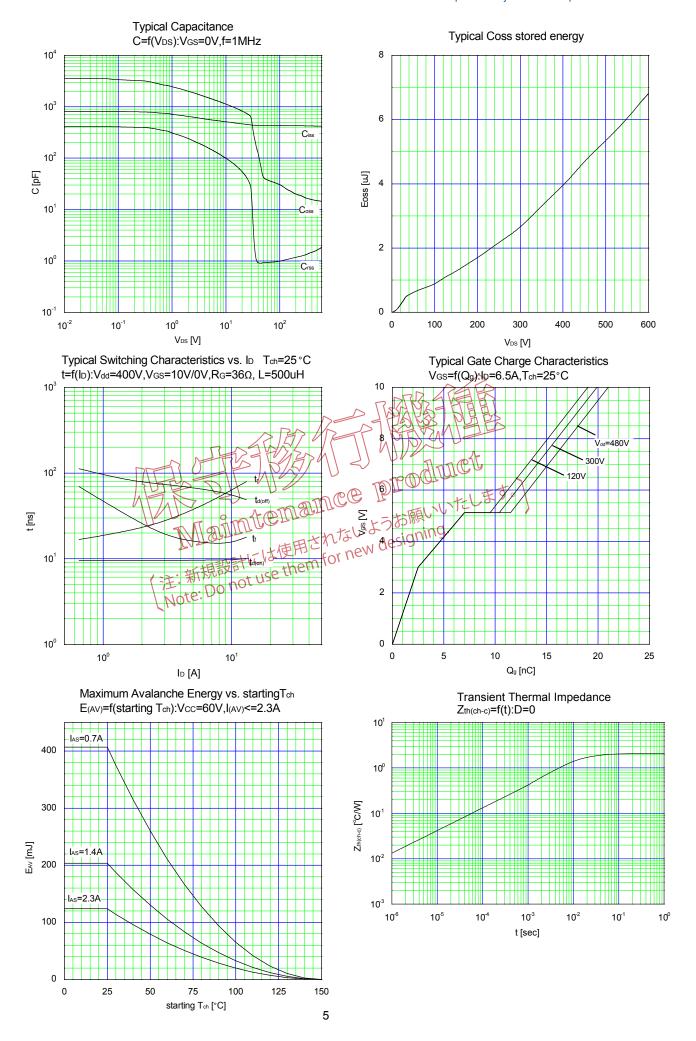
Reverse Diode	0 0				
Description	Symbol	Conditions	mintyp.	max.	Unit
Avalanche Capability	lav A	L=42.9mH, V _o =25°C See Fig. 1 and Fig.2	2.3	-	А
Diode Forward On-Voltage	Was 5	It=6.5A Ves=0V	0.9	1.35	V
Reverse Recovery Time		I=6.54 Vol. 460V Color Color	275	-	ns
Reverse Recovery Charge	OTATION.	Vosicin=short, Marios=10WoV design Re=3000 使用 for new design	- 2.7	-	μC
Peak Reverse Recovery Current	泄·新規部	See Fig. Cand Fig.7	- 18	-	А
	Note.				

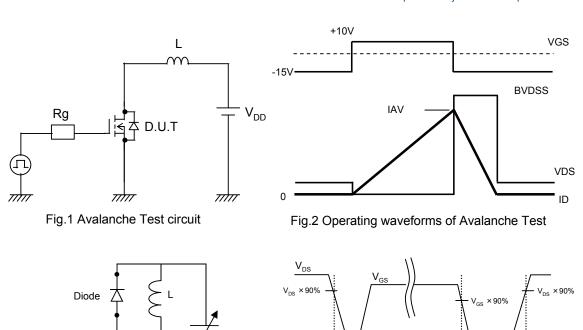
■ Thermal Resistance

Parameter	Symbol	min.	typ.	max.	Unit
Channel to Case	Rth(ch-c)	-	-	2.08	°C/W
Channel to Ambient	R _{th(ch-a)}	-	-	62	°C/W









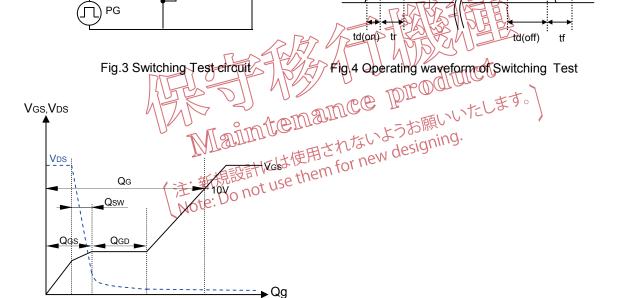


Fig.5 Operating waveform of Gate charge Test

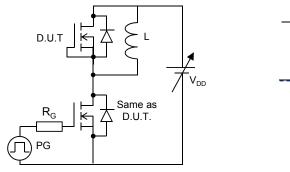


Fig.6 Reverse recovery Test circuit

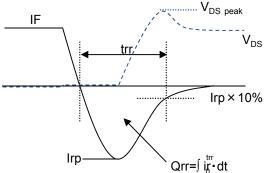
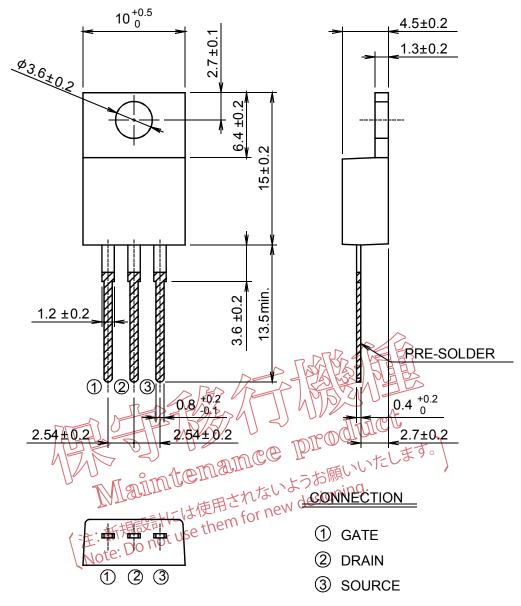


Fig.7 Operating waveform of Reverse recovery Test

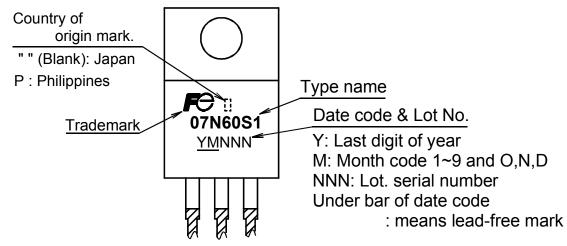
Outview: TO-220 Package



JEDEC: TO-220AB

DIMENSIONS ARE IN MILLIMETERS.

Marking



^{*} The font (font type,size) and the trademark-size might be actually different.



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